

## AGENDA

### P-2.5 COMMITTEE FOR TANTALUM & NIOBIUM CAPACITORS

WEDNESDAY, April 18, 2007

2:00 to 4:00 PM

San Diego, CA

1. **COMMITTEE ORGANIZATION AND PROCEDURES**
  - 1.1 Membership and attendance
  - 1.2 Review and approve agenda
  - 1.3 Approve minutes of last meeting , Reno, NV, Sept 27. 2006
  - 1.4 Correspondence
2. **OLD BUSINESS**
  - 2.1 Reports
    - 2.1.1 Passive Component Steering Committee (S.1).....Mike Lauri  
(Announcement of future meeting dates and locations)
    - 2.1.2 Government Specifications and Standards..... DSCC Representative
  - 2.2 Surface Mount Tantalum Capacitors
    - 2.1 Status: Standard (EIA-535BAAC), Low ESR (EIA-535BAAE)  
Discussion of new case sizes, ratings, or products....All Members
    - 2.2.2.1 Lead-frame less/face down termination molded specification?
  - 2.3 Hazardous Material IPC-1752 Spec
  - 2.4.1 Lead free solder topics - Tin Whiskers.....
  - 2.5 Update EIA 809 Tantalum Applications Guide
  - 2.6.1 Review existing specifications: J-Std-020C, IPC-9503 (MSL passives), IPC-9504 (Assembly Process Simulation for Non-IC Devices)
  - 2.7 Review and update EIA list of "active working projects
  - 2.8 Review Niobium/NbO draft specification/ PN number 5075
  - 2.9 Update EIA IS 717 Qualification specification PN 5097
3. **NEW BUSINESS**
  - 3.1.1 Address AEC Q200 Rev C preconditioning project
  - 3.2 Inputs for "All-Chairs Meeting"
4. **ADJOURNMENT**

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